

Polyethylene

Borlink™ LE0595-07

Crosslinkable Semiconductive Compound

Description

Borlink LE0595-07 is a crosslinkable black polyethylene compound, specially designed for semiconductive conductor shield or bonded insulation shield of power cables.

Applications

Borlink™ LE0595-07 is intended for following applications:

Power cables

Borlink LE0595-07 is uniquely intended for semiconductive shield of medium voltage (MV) AC cables with rated voltages up to 46 kV in combination with TR-XLPE or EPR insulation compounds. It can be used as conductor and insulation shields for bonded cable constructions and as conductor shield for strippable cable constructions.

The values are voltages between phases as defined in ICEA S-94-649.

Borlink LE0595-07 is a ready-to-use semiconductive compound. It offers excellent thermal stability which provides robust cable extrusion and crosslinking at high surface temperature, allowing for high line speed.

The excellent distribution of carbon black and additives in Borlink LE0595-07 results in a smooth semiconductive shield.

Specifications

AEIC CS8	IEC 60502-2
ANSI/ICEA S-93-639	IEC 60840
ANSI/ICEA S-94-649	UL 1072
ANSI/ICEA S-97-682	

Borlink LE0595-07 is expected to meet the applicable requirements included in the below mentioned standards provided it is processed using sound material handling, extrusion and crosslinking practices as well as appropriate testing procedures. This applies up to the maximum recommended voltage level indicated in "Applications" section above since some standards cover wider voltage ranges.

Physical properties

Property	Typical value *	Unit	Test method
Density ¹	1140	kg/m ³	ASTM D792
Low temperature brittleness ²	≤5	pieces	ASTM D746
Brittleness temperature ³	≤-40	°C	ASTM D746
Tensile strength at break ⁴	2500	psi	ASTM D638
Elongation at break after 150°C/7d ⁴	≥100	%	ASTM D638
Retained TS 150°C/7d ⁴	≥75	%	ASTM D638
Tensile strain at break ⁴	225	%	ASTM D638

* Data should not be used for specification work

¹ 23°C

² Measured on crosslinked specimens at -40°C

³ Measured on crosslinked specimens

⁴ Measured on crosslinked specimens, 20 in/min

Borlink™ is a trademark of the Borealis Group



Polyethylene

Borlink™ LE0595-07

Electrical properties

Property	Typical value *	Unit	Test method
DC Volume resistivity (23°C) ³	≤50	Ohm*cm	ASTM D991
DC Volume resistivity (90°C) ³	≤500	Ohm*cm	ASTM D991

* Data should not be used for specification work

³ Measured on crosslinked specimens

Processing techniques

Borlink LE0595-07 provides excellent surface finish and outstanding output rates, when processing conditions are optimized for the actual processing equipment and cable dimensions. Optimal conditions may vary according to the equipment used.

The required extrusion melt temperature range is approximately 240 to 260°F (115 to 125°C). Lower melt temperatures may result in a poorly mixed, uneven extrudate and higher melt temperatures may result in extrudate pre-cure or scorch. The curing configuration should be carefully controlled.

To produce a good and reliable cable, it is essential to ensure careful and clean handling of semiconductive material. Hence all material handling should preferably be conducted in closed systems. Please contact your Borealis representative for more details.

It is recommended that Borlink LE0595-07 is dried prior to extrusion. Typical drying conditions are shown below.

A screen-pack on the extruder is recommended for improved melt homogenisation. Typical processing temperature ranges for Borlink LE0595-07 are shown below.

Processing setting	Typical value/range
Drying temperature ⁵	60 °C
Drying temperature ⁵	160 °F
Melt temperature	115 - 125 °C
Melt temperature	240 - 260 °F

⁵ 4 hours, with dehumidified air

Packaging and storage

Borlink™ LE0595-07 should be stored in dry conditions at temperatures below 50°C and protected from UV-light. Improper storage can initiate degradation, which can result in odour generation and colour changes and can have negative effects on the physical properties of this product.

Product compliance documents

Latest versions of product safety information sheets (PSIS), product safety data sheets (SDS) and other product liability documents are available in our website www.borealisgroup.com.

Sustainability aspects

Borealis is ever mindful of the impact of our products on the planet. We promote Design for Circularity (DfC) and Design for Recycling (DfR) to conserve natural resources and to reduce the environmental impact of products over their entire lifetime (including production, use phase and after phase). DfR helps ensure that material can be effectively recycled while maximizing the material performance efficiency.

Further information on sustainability and Design for Recycling (DfR) can be found from our websites www.borealisgroup.com and www.borealiseverminds.com.

Borlink™ is a trademark of the Borealis Group



Polyethylene

Borlink™ LE0595-07

Disclaimer

The product(s) mentioned herein are not intended to be used for medical, pharmaceutical or healthcare applications and we do not support their use for such applications.

To the best of our knowledge, the information contained herein is accurate and reliable as of the date of publication; however we do not assume any liability whatsoever for the accuracy and completeness of such information.

Borealis makes no warranties which extend beyond the description contained herein. Nothing herein shall constitute any warranty of merchantability or fitness for a particular purpose.

It is the customer's responsibility to inspect and test our products in order to satisfy itself as to the suitability of the products for the customer's particular purpose. The customer is responsible for the appropriate, safe and legal use, processing and handling of our products.

No liability can be accepted in respect of the use of any Borealis product in conjunction with any other products and/or materials. The information contained herein relates exclusively to our products when not used in conjunction with any other material unless as specifically provided for in the test methods stated above.